



Integrated  
Circuit  
Systems, Inc.

**PRELIMINARY**

# ICS84330-01

## 700MHz, Low JITTER, CRYSTAL-TO-3.3V DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

### GENERAL DESCRIPTION

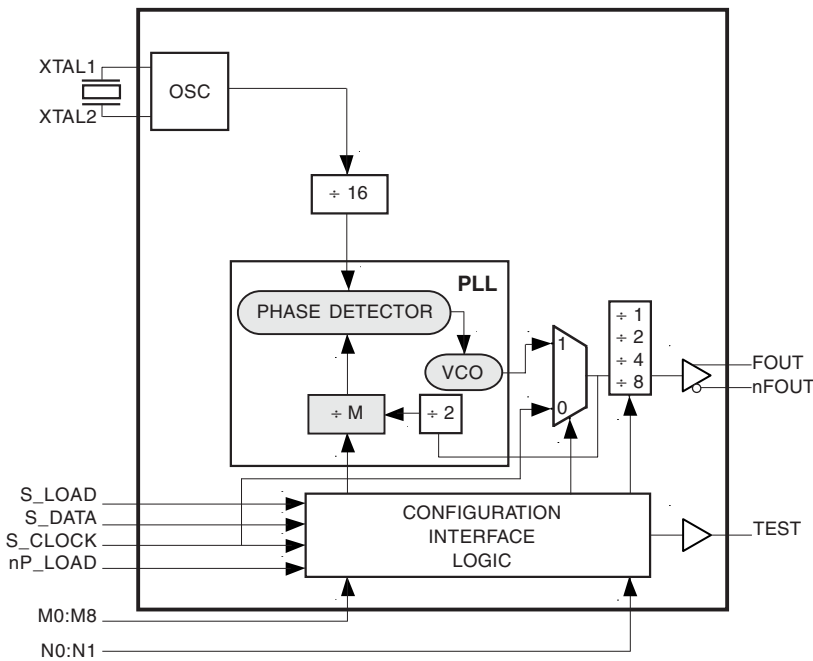


The ICS84330-01 is a general purpose, single output high frequency synthesizer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The VCO operates at a frequency range of 200MHz to 700MHz. The VCO and output frequency can be programmed using the serial or parallel interfaces to the configuration logic. The output can be configured to divide the VCO frequency by 1, 2, 4, and 8. Output frequency steps from 250KHz to 2MHz can be achieved using a 16MHz crystal depending on the output divider setting.

### FEATURES

- Fully integrated PLL, no external loop filter requirements
- 1 differential 3.3V LVPECL output
- Crystal oscillator interface range: 10MHz to 25MHz
- Output frequency range: 25MHz to 700MHz
- VCO range: 200MHz to 700MHz
- Parallel or serial interface for programming M and N dividers during power-up
- RMS Period jitter: TBD
- Cycle-to-cycle jitter: 15ps (typical)
- 3.3V supply voltage
- 0°C to 70°C ambient operating temperature
- Pin compatible with the SY89430V

### BLOCK DIAGRAM

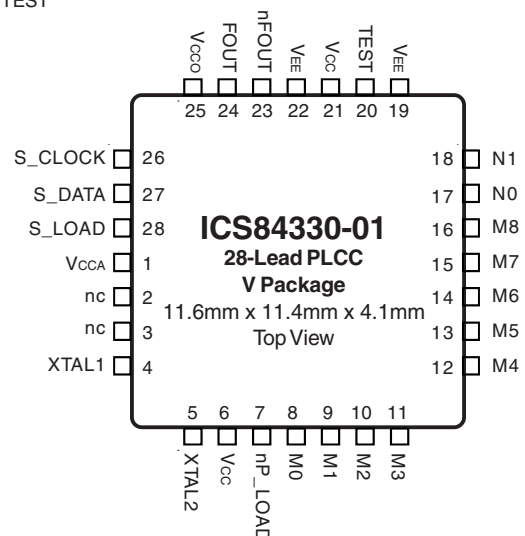


### PIN ASSIGNMENT

M0	1	28	nP_LOAD
M1	2	27	Vcc
M2	3	26	XTAL2
M3	4	25	XTAL1
M4	5	24	nc
M5	6	23	nc
M6	7	22	VCCA
M7	8	21	S_LOAD
M8	9	20	S_DATA
N0	10	19	S_CLOCK
N1	11	18	VCCO
VEE	12	17	FOUT
TEST	13	16	nFOUT
Vcc	14	15	VEE

#### ICS84330-01 28-Lead SOIC

7.5mm x 18.05mm x 2.25mm body package  
**M Package**  
Top View



The Preliminary Information presented herein represents a product in prototyping or pre-production. The noted characteristics are based on initial product characterization. Integrated Circuit Systems, Incorporated (ICS) reserves the right to change any circuitry or specifications without notice.



**FUNCTIONAL DESCRIPTION**

*NOTE: The functional description that follows describes operation using a 16MHz crystal. Valid PLL loop divider values for different crystal or input frequencies are defined in the Input Frequency Characteristics, Table 6, NOTE 1.*

The ICS84330-01 features a fully integrated PLL and therefore requires no external components for setting the loop bandwidth. A quartz crystal is used as the input to the on-chip oscillator. The output of the oscillator is divided by 16 prior to the phase detector. With a 16MHz crystal this provides a 1MHz reference frequency. The VCO of the PLL operates over a range of 200MHz to 700MHz. The output of the M divider is also applied to the phase detector.

The phase detector and the M divider force the VCO output frequency to be 2M times the reference frequency divided by 16 by adjusting the VCO control voltage. Note that for some values of M (either too high or too low), the PLL will not achieve lock. The output of the VCO is scaled by a divider prior to being sent to each of the LVPECL output buffers. The divider provides a 50% output duty cycle.

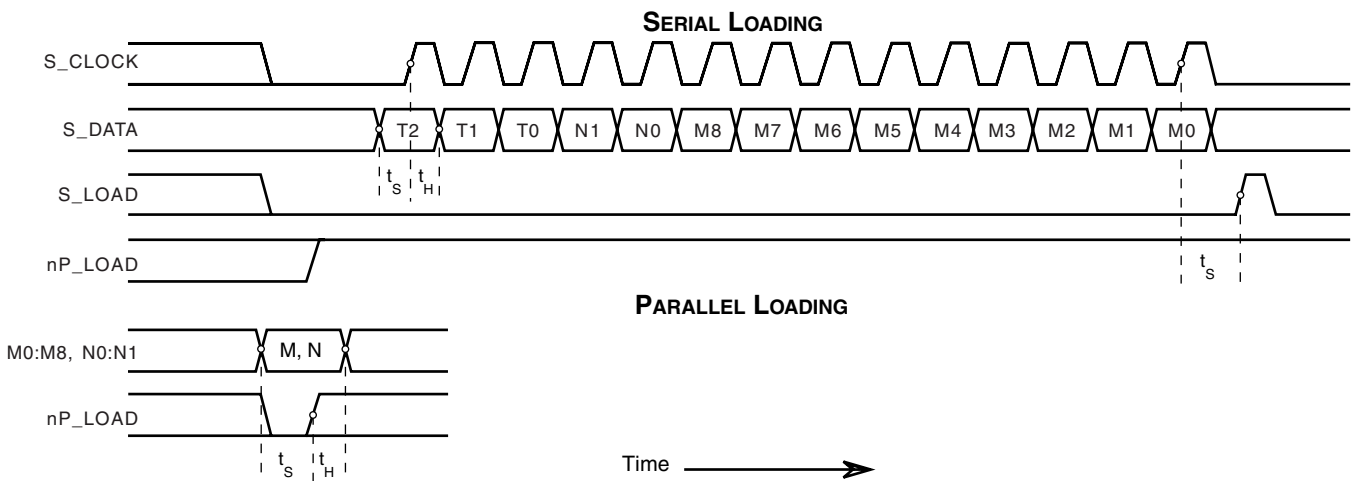
The programmable features of the ICS84330-01 support two input modes to program the M divider and N output divider. The two input operational modes are parallel and serial. Figure 1 shows the timing diagram for each mode. In parallel mode the nP\_LOAD input is LOW. The data on inputs M0 through M8 and

N0 through N1 is passed directly to the M divider and N output divider. On the LOW-to-HIGH transition of the nP\_LOAD input, the data is latched and the M divider remains loaded until the next LOW transition on nP\_LOAD or until a serial event occurs. The TEST output is Mode 000 (shift register out) when operating in the parallel input mode. The relationship between the VCO frequency, the crystal frequency and the M divider is defined as follows:  $f_{VCO} = \frac{f_{xtal}}{16} \times 2M$

The M value and the required values of M0 through M8 are shown in Table 3B, Programmable VCO Frequency Function Table. Valid M values for which the PLL will achieve lock are defined as  $100 \leq M \leq 350$ . The frequency out is defined as follows:  $f_{out} = \frac{f_{VCO}}{N} = \frac{f_{xtal}}{16} \times \frac{2M}{N}$

Serial operation occurs when nP\_LOAD is HIGH and S\_LOAD is LOW. The shift register is loaded by sampling the S\_DATA bits with the rising edge of S\_CLOCK. The contents of the shift register are loaded into the M divider when S\_LOAD transitions from LOW-to-HIGH. The M divide and N output divide values are latched on the HIGH-to-LOW transition of S\_LOAD. If S\_LOAD is held HIGH, data at the S\_DATA input is passed directly to the M divider on each rising edge of S\_CLOCK. The serial mode can be used to program the M and N bits and test bits T2:T0. The internal registers T2:T0 determine the state of the TEST output as follows:

T2	T1	T0	TEST Output	fOUT
0	0	0	Shift Register Out	fOUT
0	0	1	High	fOUT
0	1	0	PLL Reference Xtal ÷ 16	fOUT
0	1	1	(VCO ÷ M) / 2 (non 50% Duty M divider)	fOUT
1	0	0	fOUT LVCMOS Output Frequency < 200MHz	fOUT
1	0	1	Low	fOUT
1	1	0	(S_CLOCK ÷ M) / 2 (non 50% Duty Cycle M divider)	S_CLOCK ÷ N divider
1	1	1	fOUT ÷ 4	fOUT



**FIGURE 1. PARALLEL & SERIAL LOAD OPERATIONS**



**TABLE 1. PIN DESCRIPTIONS**

Name	Type		Description
V <sub>CC</sub>	Power		Core supply pins.
V <sub>CCA</sub>	Power		Analog supply pin for the PLL.
V <sub>EE</sub>	Power		Negative supply pins.
V <sub>CCO</sub>	Power		Output supply pin.
nc	Unused		Do not connect.
XTAL1, XTAL2	Input		Crystal oscillator interface. XTAL1 is the input. XTAL2 is the output.
nP_LOAD	Input	Pullup	Parallel load input. Determines when data present at M8:M0 is loaded into M divider, and when data present at N1:N0 sets the N output divide value. LVCMOS / LVTTTL interface levels.
S_CLOCK	Input	Pulldown	Clocks the serial data present at S_DATA input into the shift register on the rising edge of S_CLOCK. LVCMOS / LVTTTL interface levels.
S_DATA	Input	Pulldown	Shift register serial input. Data sampled on the rising edge of S_CLOCK. LVCMOS / LVTTTL interface levels.
S_LOAD	Input	Pulldown	Controls transition of data from shift register into the M divider. LVCMOS / LVTTTL interface levels.
M0, M1, M2 M3, M4, M5 M6, M7, M8	Input	Pullup	M divider inputs. Data latched on LOW-to-HIGH transition of nP_LOAD input. LVCMOS / LVTTTL interface levels.
N0, N1	Input	Pullup	Determines N output divider value as defined in Table 3C Function Table. LVCMOS / LVTTTL interface levels.
TEST	Output		Test output which is used in the serial mode of operation. LVCMOS / LVTTTL interface levels.
nFOUT, FOUT	Output		Differential output for the synthesizer. 3.3V LVPECL interface levels.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

**TABLE 2. PIN CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C <sub>IN</sub>	Input Capacitance			4		pF
R <sub>PULLUP</sub>	Input Pullup Resistor			51		KΩ
R <sub>PULLDOWN</sub>	Input Pulldown Resistor			51		KΩ



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**TABLE 3A. PARALLEL AND SERIAL MODE FUNCTION TABLE**

Inputs						Conditions
nP_LOAD	M	N	S_LOAD	S_CLOCK	S_DATA	
X	X	X	X	X	X	Reset. M and N bits are all set HIGH.
L	Data	Data	X	X	X	Data on M and N inputs passed directly to M divider and N output divider. TEST mode 000.
↑	Data	Data	X	X	X	Data is latched into input registers and remains loaded until next LOW transition or until a serial event occurs.
H	X	X	L	↑	Data	Serial input mode. Shift register is loaded with data on S_DATA on each rising edge of S_CLOCK.
H	X	X	↑	L	Data	Contents of the shift register are passed to the M divider and N output divider.
H	X	X	↓	L	Data	M divide and N output divide values are latched.
H	X	X	L	X	X	Parallel or serial input do not affect shift registers.
H	X	X	H	↑	Data	S_DATA passed directly to M Divider as it is clocked.

NOTE: L = LOW  
H = HIGH  
X = Don't care  
↑ = Rising edge transition  
↓ = Falling edge transition

**TABLE 3B. PROGRAMMABLE VCO FREQUENCY FUNCTION TABLE**

VCO Frequency (MHz)	M Divide	256	128	64	32	16	8	4	2	1
		M8	M7	M6	M5	M4	M3	M2	M1	M0
200	100	0	0	1	1	0	0	1	0	0
202	101	0	0	1	1	0	0	1	0	1
204	102	0	0	1	1	0	0	1	1	0
206	103	0	0	1	1	0	0	1	1	1
•	•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•	•
696	348	1	0	1	0	1	1	1	0	0
698	349	1	0	1	0	1	1	1	0	1
700	350	1	0	1	0	1	1	1	1	0

NOTE 1: These M divide values and the resulting frequencies correspond to a crystal frequency of 16MHz.

**TABLE 3C. PROGRAMMABLE OUTPUT DIVIDER FUNCTION TABLE**

Inputs		N Divider Value	Output Frequency (MHz)	
N1	N0		Minimum	Maximum
0	0	2	100	350
0	1	4	50	175
1	0	8	25	87.5
1	1	1	200	700



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**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, $V_{CC}$	4.6V
Inputs, $V_i$	-0.5V to $V_{CC} + 0.5V$
Outputs, $I_o$	
Continuous Current	50mA
Surge Current	100mA
Package Thermal Impedance, $\theta_{JA}$	37.8°C/W (0 lfpm)
Storage Temperature, $T_{STG}$	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

**TABLE 4A. DC POWER SUPPLY CHARACTERISTICS,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{CC}$	Core Supply Voltage		3.135	3.3	3.465	V
$V_{CCA}$	Analog Supply Voltage		3.135	3.3	3.465	V
$I_{EE}$	Power Supply Current			115		mA
$I_{CCA}$	Analog Supply Current			15		mA

**TABLE 4B. LVCMOS / LVTTTL DC CHARACTERISTICS,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{IH}$	Input High Voltage		2		$V_{CC} + 0.3$	V
$V_{IL}$	Input Low Voltage		-0.3		0.8	V
$I_{IH}$	Input High Current	M0:M8, N0, N1, nP_LOAD, XTAL_SEL	$V_{CC} = V_{IN} = 3.465V$		5	$\mu A$
		S_LOAD, S_DATA, S_CLOCK	$V_{CC} = V_{IN} = 3.465V$		150	$\mu A$
$I_{IL}$	Input Low Current	M0:M8, N0, N1, nP_LOAD, XTAL_SEL	$V_{CC} = 3.465V, V_{IN} = 0V$	-150		$\mu A$
		S_LOAD, S_DATA, S_CLOCK	$V_{CC} = 3.465V, V_{IN} = 0V$	-5		$\mu A$
$V_{OH}$	Output High Voltage; NOTE 1		2.6			V
$V_{OL}$	Output Low Voltage; NOTE 1				0.5	V

NOTE 1: Outputs terminated with 50 $\Omega$  to  $V_{CCO}/2$ .

**TABLE 4C. LVPECL DC CHARACTERISTICS,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{OH}$	Output High Voltage; NOTE 1		$V_{CC} - 1.4$		$V_{CC} - 0.9$	V
$V_{OL}$	Output Low Voltage; NOTE 1		$V_{CC} - 2.0$		$V_{CC} - 1.7$	V
$V_{SWING}$	Peak-to-Peak Output Voltage Swing		0.6		0.95	V

NOTE 1: Outputs terminated with 50 $\Omega$  to  $V_{CCO} - 2V$ .



**TABLE 5. CRYSTAL CHARACTERISTICS**

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency		10		25	MHz
Equivalent Series Resistance (ESR)				50	$\Omega$
Shunt Capacitance				7	pF

**TABLE 6. INPUT FREQUENCY CHARACTERISTICS,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$f_{IN}$	Input Frequency	XTAL; NOTE 1	10		25	MHz
		S_CLOCK			50	MHz

NOTE 1: For the crystal frequency range the M value must be set to achieve the minimum or maximum VCO frequency range of 200MHz or 700MHz. Using the minimum frequency of 10MHz, valid values of M are  $160 \leq M \leq 511$ . Using the maximum frequency of 25MHz, valid values of M are  $64 \leq M \leq 224$ .

**TABLE 7. AC CHARACTERISTICS,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$F_{OUT}$	Output Frequency				700	MHz
$f_{jit(per)}$	Period Jitter, RMS; NOTE 1, 2			TBD		ps
$f_{jit(cc)}$	Cycle-to-Cycle Jitter; NOTE 1, 2			15		ps
$t_{R'}$ , $t_{F'}$	Output Rise/Fall Time	20% to 80%		500		ps
$t_S$	Setup Time	S_DATA to S_CLOCK	20			ns
		S_CLOCK to S_LOAD	20			ns
		M, N to nP_LOAD	20			ns
$t_H$	Hold Time	S_DATA to S_CLOCK	20			ns
		M, N to nP_LOAD	20			ns
$t_L$	PLL Lock Time				10	ms
odc	Output Duty Cycle			50		%

See Parameter Measurement Information section.

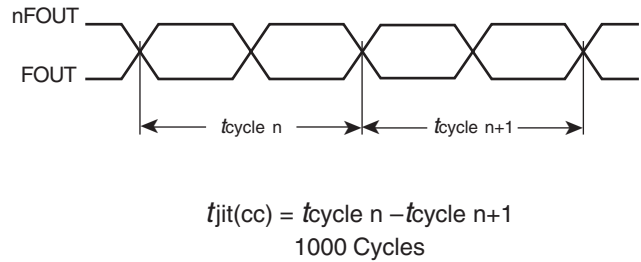
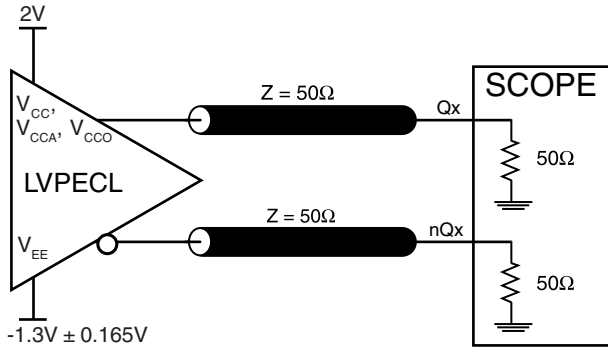
Characterized using a 16MHz XTAL.

NOTE 1: This parameter is defined in accordance with JEDEC Standard 65

NOTE 2: See Applications section.

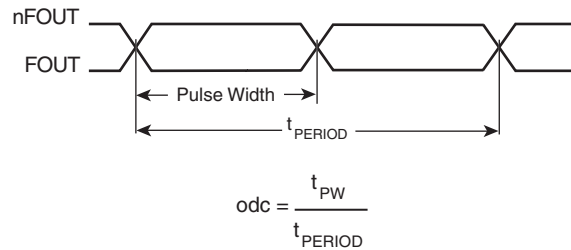
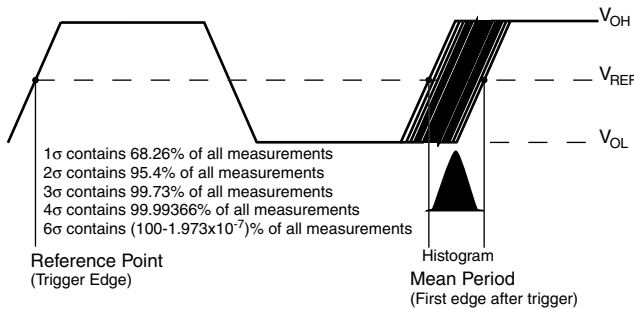


**PARAMETER MEASUREMENT INFORMATION**



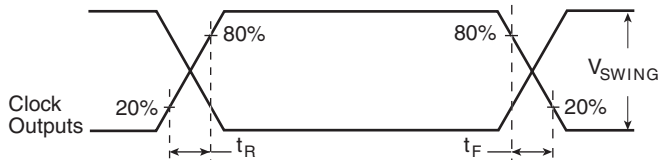
**3.3V OUTPUT LOAD AC TEST CIRCUIT**

**CYCLE-TO-CYCLE JITTER**



**PERIOD JITTER**

**OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD**



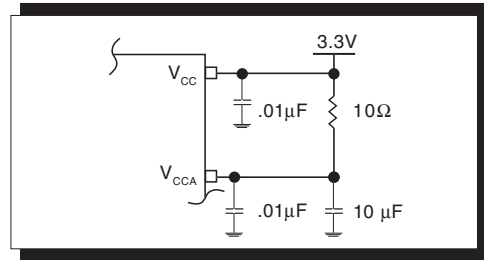
**OUTPUT RISE/FALL TIME**



**APPLICATION INFORMATION**

**POWER SUPPLY FILTERING TECHNIQUES**

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS84330-01 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL.  $V_{CC}$ ,  $V_{CCA}$  and  $V_{CCO}$  should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 2* illustrates how a 10Ω resistor along with a 10μF and a .01μF bypass capacitor should be connected to each  $V_{CCA}$  pin.



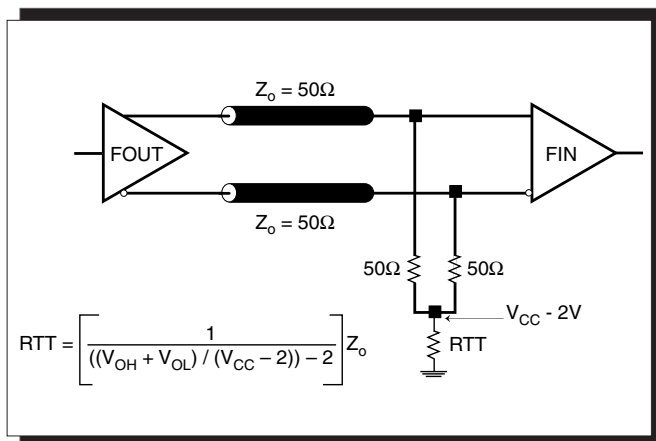
**FIGURE 2. POWER SUPPLY FILTERING**

**TERMINATION FOR LVPECL OUTPUTS**

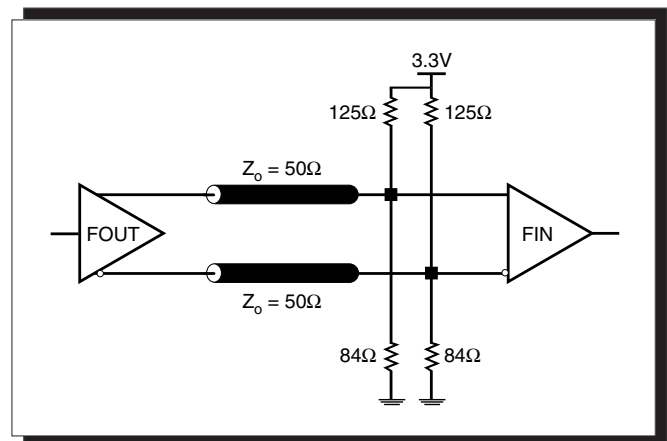
The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to

drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 3A and 3B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.



**FIGURE 3A. LVPECL OUTPUT TERMINATION**



**FIGURE 3B. LVPECL OUTPUT TERMINATION**

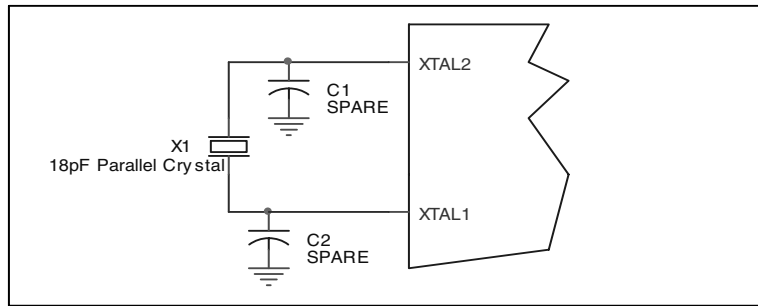




**CRYSTAL INTERFACE**

The ICS84330-01 has been characterized with 18pF parallel resonant crystals. The external tuning capacitors C1 and C2 are not required if an 18pF parallel resonant crystal is used. If there is space available, it is recommended to provide spare

footprints C1 and C2 (size 0603 or 0402) while laying out the P.C. Board. These footprints provide option of optimizing frequency accuracy if needed.



**FIGURE 4. CRYSTAL OSCILLATOR INTERFACE**



## POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS84330-01. Equations and example calculations are also provided.

### 1. Power Dissipation.

The total power dissipation for the ICS84330-01 is the sum of the core power plus the power dissipated in the load(s).

The following is the power dissipation for  $V_{CC} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

**NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> =  $V_{CC\_MAX} * I_{EE\_MAX} = 3.465V * 115mA = 398.5mW$
- Power (outputs)<sub>MAX</sub> = **30mW/Loaded Output pair**  
If all outputs are loaded, the total power is  $1 * 30mW = 30mW$

$$\text{Total Power}_{MAX} (3.465V, \text{ with all outputs switching}) = 398.5mW + 30mW = 428.5mW$$

### 2. Junction Temperature.

Junction temperature,  $T_j$ , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for  $T_j$  is as follows:  $T_j = \theta_{JA} * Pd\_total + T_A$

$T_j$  = Junction Temperature

$\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

$Pd\_total$  = Total Device Power Dissipation (example calculation is in section 1 above)

$T_A$  = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 31.1°C/W per Table 8A below.

Therefore,  $T_j$  for an ambient temperature of 70°C with all outputs switching is:

$$70^\circ C + 0.429W * 31.1^\circ C/W = 83.3^\circ C. \text{ This is well below the limit of } 125^\circ C.$$

This calculation is only an example.  $T_j$  will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

**TABLE 8A. THERMAL RESISTANCE  $\theta_{JA}$  FOR 28-PIN PLCC, FORCED CONVECTION**

	$\theta_{JA}$ by Velocity (Linear Feet per Minute)		
	0	200	500
Multi-Layer PCB, JEDEC Standard Test Boards	37.8°C/W	31.1°C/W	28.3°C/W

**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

**TABLE 8B. THERMAL RESISTANCE  $\theta_{JA}$  FOR 28-PIN SOIC, FORCED CONVECTION**

	$\theta_{JA}$ by Velocity (Linear Feet per Minute)		
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	76.2°C/W	60.8°C/W	53.2°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	46.2°C/W	39.7°C/W	36.8°C/W

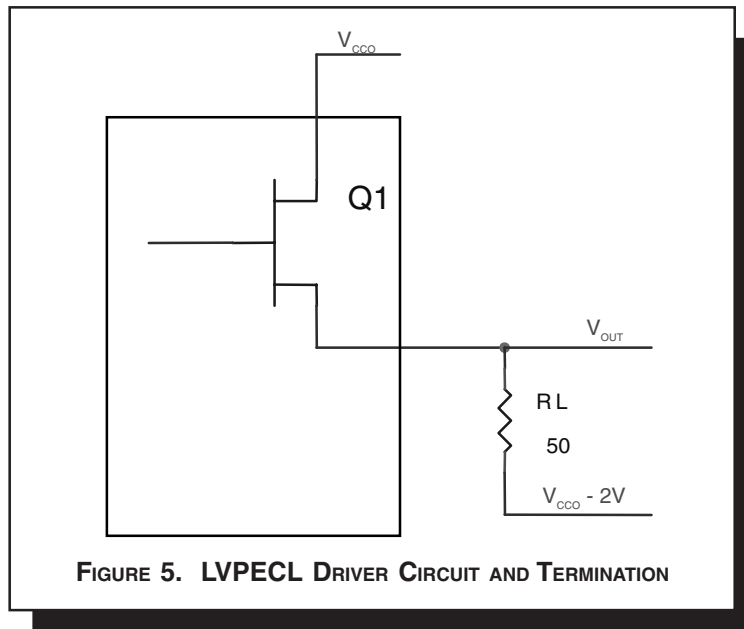
**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.



3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in the *Figure 5*.



**FIGURE 5. LVPECL DRIVER CIRCUIT AND TERMINATION**

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of  $V_{CCO} - 2V$ .

- For logic high,  $V_{OUT} = V_{OH\_MAX} = V_{CCO\_MAX} - 0.9V$

$$(V_{CCO\_MAX} - V_{OH\_MAX}) = 0.9V$$

- For logic low,  $V_{OUT} = V_{OL\_MAX} = V_{CCO\_MAX} - 1.7V$

$$(V_{CCO\_MAX} - V_{OL\_MAX}) = 1.7V$$

$Pd\_H$  is power dissipation when the output drives high.  
 $Pd\_L$  is the power dissipation when the output drives low.

$$Pd\_H = [(V_{OH\_MAX} - (V_{CCO\_MAX} - 2V))/R_L] * (V_{CCO\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CCO\_MAX} - V_{OH\_MAX}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd\_L = [(V_{OL\_MAX} - (V_{CCO\_MAX} - 2V))/R_L] * (V_{CCO\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CCO\_MAX} - V_{OL\_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair =  $Pd\_H + Pd\_L = 30mW$



**RELIABILITY INFORMATION**

**TABLE 9A.  $\theta_{JA}$  VS. AIR FLOW FOR 28 LEAD PLCC TABLE**

$\theta_{JA}$ by Velocity (Linear Feet per Minute)			
	0	200	500
Multi-Layer PCB, JEDEC Standard Test Boards	37.8°C/W	31.1°C/W	28.3°C/W

**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

**TABLE 9B.  $\theta_{JA}$  VS. AIR FLOW FOR 28 LEAD SOIC TABLE**

$\theta_{JA}$ by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	76.2°C/W	60.8°C/W	53.2°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	46.2°C/W	39.7°C/W	36.8°C/W

**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

**TRANSISTOR COUNT**

The transistor count for ICS84330-01 is: 4442



Integrated  
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**PRELIMINARY**

**ICS84330-01**  
700MHz, Low JITTER, CRYSTAL-TO-3.3V  
DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

PACKAGE OUTLINE - V SUFFIX FOR 28 LEAD PLCC

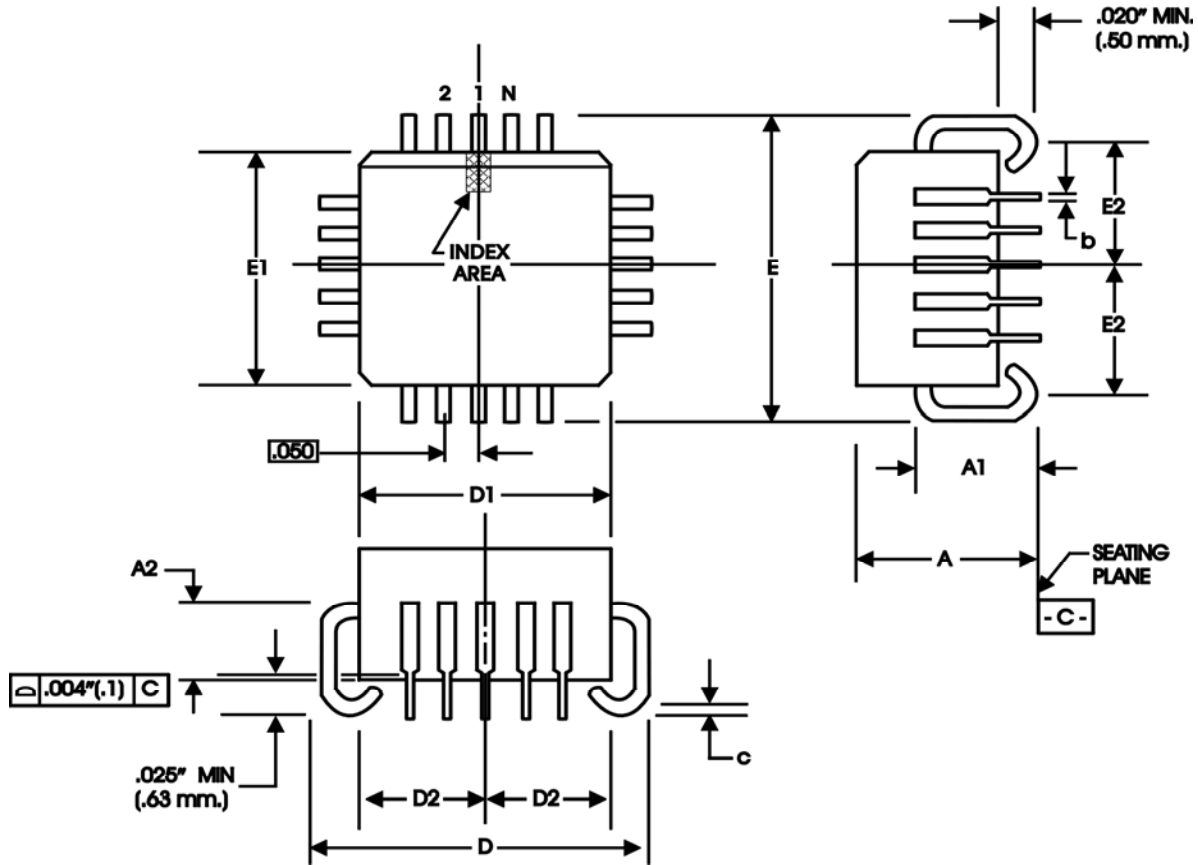


TABLE 10A. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS		
SYMBOL	MINIMUM	MAXIMUM
N	28	
A	4.19	4.57
A1	2.29	3.05
A2	1.57	2.11
b	0.33	0.53
c	0.19	0.32
D	12.32	12.57
D1	11.43	11.58
D2	4.85	5.56
E	12.32	12.57
E1	11.43	11.58
E2	4.85	5.56

Reference Document: JEDEC Publication 95, MS-018

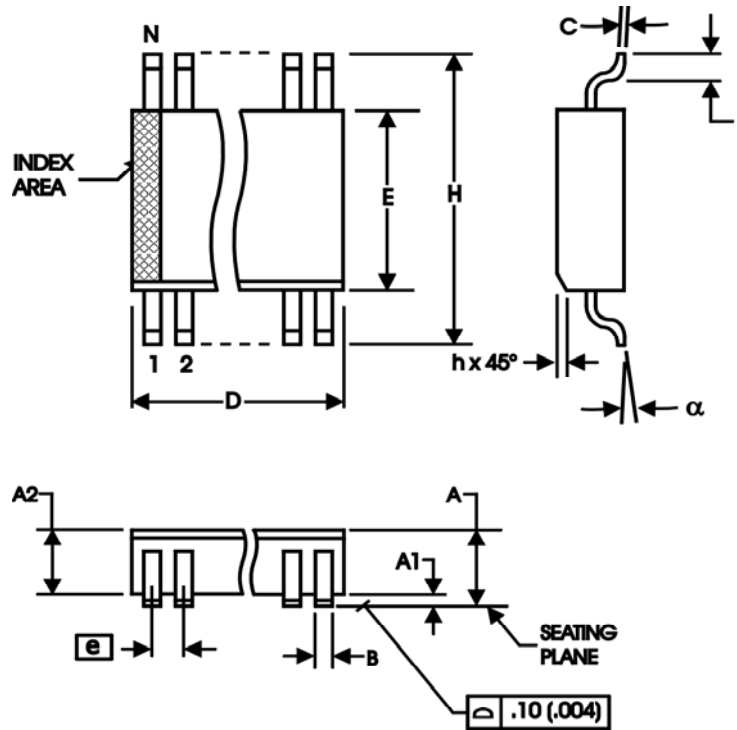


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DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

**PACKAGE OUTLINE - M SUFFIX FOR 28 LEAD SOIC**



**TABLE 10B. PACKAGE DIMENSIONS**

SYMBOL	Millimeters	
	MINIMUM	MAXIMUM
N	28	
A	--	2.65
A1	0.10	--
A2	2.05	2.55
B	0.33	0.51
C	0.18	0.32
D	17.70	18.40
E	7.40	7.60
e	1.27 BASIC	
H	10.00	10.65
h	0.25	0.75
L	0.40	1.27
α	0°	8°

Reference Document: JEDEC Publication 95, MS-013, MO-119



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**PRELIMINARY**

**ICS84330-01**  
**700MHz, Low JITTER, CRYSTAL-TO-3.3V**  
**DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER**

**TABLE 11. ORDERING INFORMATION**

<b>Part/Order Number</b>	<b>Marking</b>	<b>Package</b>	<b>Count</b>	<b>Temperature</b>
ICS84330CV-01	ICS84330CV-01	28 Lead PLCC	38 per Tube	0°C to 70°C
ICS84330CVT-01	ICS84330CV-01	28 Lead PLCC on Tape and Reel	500	0°C to 70°C
ICS84330CM-01	ICS84330CM-01	28 Lead SOIC	26 per Tube	0°C to 70°C
ICS84330CM-01T	ICS84330CM-01	28 Lead SOIC on Tape and Reel	1000	0°C to 70°C

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